



POWER-MOS FET

FIELD EFFECT POWER TRANSISTOR

**IRFD1Z0,1Z1
D82AL2,K2**

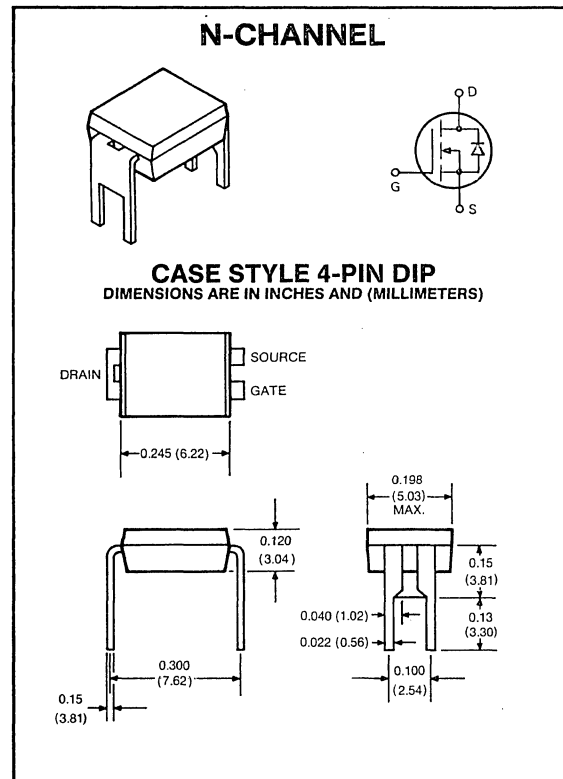
**0.5 AMPERES
100, 60 VOLTS
R_{DS(ON)} = 2.4 Ω**

This series of N-Channel Enhancement-mode Power MOSFETs utilizes GE's advanced Power DMOS technology to achieve low on-resistance with excellent device ruggedness and reliability.

This design has been optimized to give superior performance in most switching applications including: switching power supplies, inverters, converters and solenoid/relay drivers. Also, the extended safe operating area with good linear transfer characteristics makes it well suited for many linear applications such as audio amplifiers and servo motors.

Features

- Polysilicon gate — Improved stability and reliability
- No secondary breakdown — Excellent ruggedness
- Ultra-fast switching — Independent of temperature
- Voltage controlled — High transconductance
- Low input capacitance — Reduced drive requirement
- Excellent thermal stability — Ease of paralleling



maximum ratings ($T_A = 25^\circ\text{C}$) (unless otherwise specified)

RATING	SYMBOL	IRFD1Z0/D82AL2	IRFD1Z1/D82AK2	UNITS
Drain-Source Voltage	V_{DSS}	100	60	Volts
Drain-Gate Voltage, $R_{GS} = 1M\Omega$	V_{DGR}	100	60	Volts
Continuous Drain Current @ $T_A = 25^\circ\text{C}^{(1)}$ @ $T_A = 100^\circ\text{C}$	I_D	0.50 0.31	0.50 0.31	A A
Pulsed Drain Current ⁽²⁾	I_{DM}	4.0	4.0	A
Gate-Source Voltage	V_{GS}	± 20	± 20	Volts
Total Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate Above 25°C	P_D	1.2 9.6	1.2 9.6	Watts W/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{STG}	-55 to 150	-55 to 150	$^\circ\text{C}$

thermal characteristics

Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	105	105	$^\circ\text{C}/\text{W}$
Maximum Lead Temperature for Soldering Purposes: $\frac{1}{8}$ " from Case for 5 Seconds	T_L	300	300	$^\circ\text{C}$

(1) Device mounted to vertical pc board in free air with drain lead soldered to 0.5 in. minimum copper run area.

(2) Repetitive Rating: Pulse width limited by max. junction temperature.

electrical characteristics ($T_C = 25^\circ\text{C}$) (unless otherwise specified)

CHARACTERISTIC	SYMBOL	MIN	TYP	MAX	UNIT
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off characteristics

Drain-Source Breakdown Voltage ($V_{GS} = 0V, I_D = 250\mu A$)	IRFD1Z0/D82AL2 IRFD1Z1/D82AK2	BV_{DSS}	100 60	— —	— —	Volts
Zero Gate Voltage Drain Current ($V_{DS} = \text{Max Rating}, V_{GS} = 0V, T_A = 25^\circ\text{C}$) ($V_{DS} = \text{Max Rating}, \times 0.8, V_{GS} = 0V, T_A = 125^\circ\text{C}$)		I_{DSS}	— —	— —	250 1000	μA
Gate-Source Leakage Current ($V_{GS} = \pm 20V$)		I_{GSS}	—	—	± 500	nA

on characteristics*

Gate Threshold Voltage ($V_{DS} = V_{GS}, I_D = 250\mu A$)	$T_A = 25^\circ\text{C}$	$V_{GS(TH)}$	2.0	—	4.0	Volts
Drain Source On-State Voltage ($V_{GS} = 10V$)	$I_D = 0.25A$ $I_D = 0.50A$ $I_D = 0.25A, T_A = 125^\circ\text{C}$	$V_{DS(ON)}$	— — —	0.55 1.10 0.90	0.6 — —	Volts
Static Drain-Source On-State Resistance ($V_{GS} = 10V, I_D = 0.25A$)		$R_{DS(ON)}$	—	2.2	2.4	Ohms
Forward Transconductance ($V_{DS} = 10V, I_D = 0.25A$)		g_{fs}	—	0.2	—	mhos

dynamic characteristics

Input Capacitance	$V_{GS} = 0V$	C_{iss}	—	36	70	pF
Output Capacitance	$V_{DS} = 25V$	C_{oss}	—	20	30	pF
Reverse Transfer Capacitance	$f = 1\text{ MHz}$	C_{rss}	—	7	10	pF

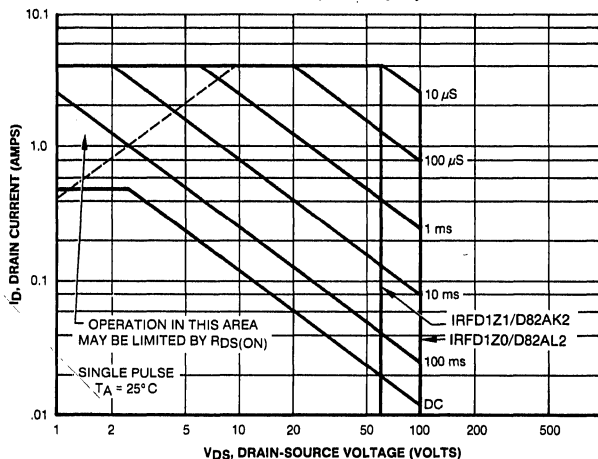
switching characteristics*

Turn-on Delay Time	$V_{DS} = 30V$	$t_{d(on)}$	—	6	—	ns
Rise Time	$I_D = 0.25A, V_{GS} = 15V$	t_r	—	6	—	ns
Turn-off Delay Time	$R_{GEN} = 50\Omega, R_{GS} = 12.5\Omega$	$t_{d(off)}$	—	12	—	ns
Fall Time	$(R_{GS} \text{ (EQUIV.)} = 10\Omega)$	t_f	—	7	—	ns

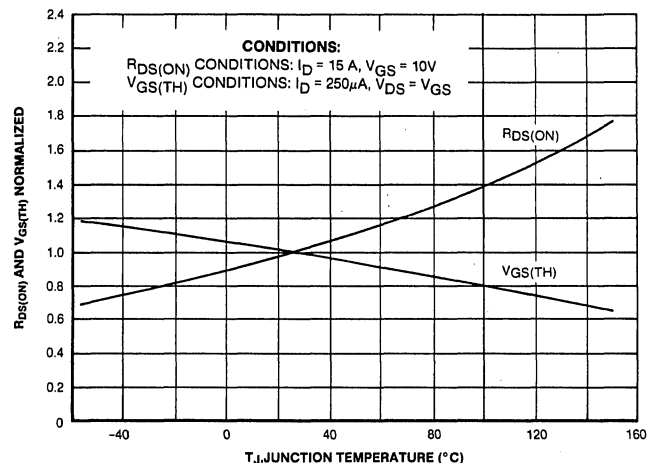
source-drain diode ratings and characteristics*

Continuous Source Current		I_S	—	—	0.5	A
Pulsed Source Current		I_{SM}	—	—	4.0	A
Diode Forward Voltage ($T_A = 25^\circ\text{C}, V_{GS} = 0V, I_S = 0.5A$)		V_{SD}	—	0.9	1.5	Volts
Reverse Recovery Time ($I_S = 0.5A, di_S/dt = 100A/\mu s, V_{DS} = 40V \text{ Max.}, T_A = 125^\circ\text{C}$)		t_{rr}	—	65	—	ns

*Pulse Test: Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$



MAXIMUM SAFE OPERATING AREA



TYPICAL NORMALIZED $R_{DS(ON)}$ AND $V_{GS(TH)}$ VS. TEMP.